

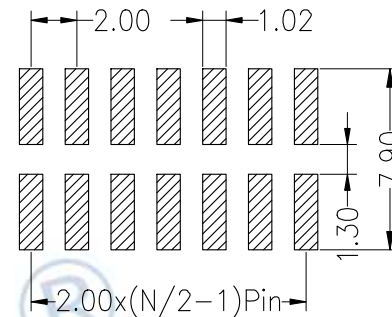
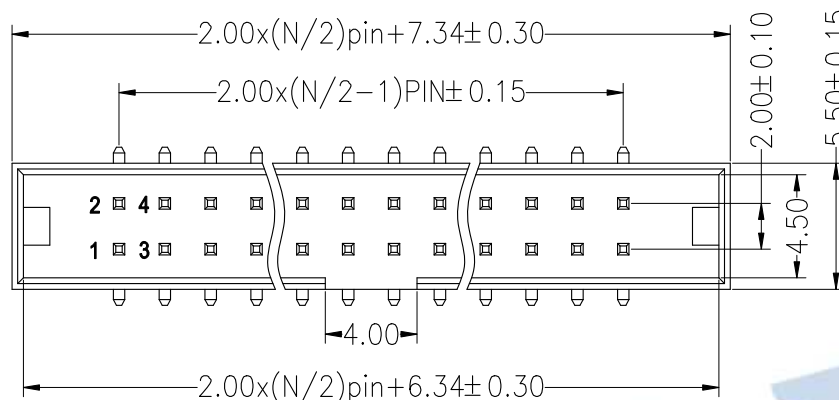


SPECIFICATIONS

Rated Current:2.0AMP
 Contact Resistance:20mΩ Max
 Withstand Voltage:400V AC/DC
 Insulation Resistance:800MΩ Min
 Operation Temperature:-40°C to +105°C

Contact Material:Brass
 Contact Plating:Au or Sn Over Ni
 Insulator Material:Polyester(UL94V-0)
 SResistance To Soldering Heat:
 260° C±5° C, 10s(PA6T&PA9T&LCP insulator)

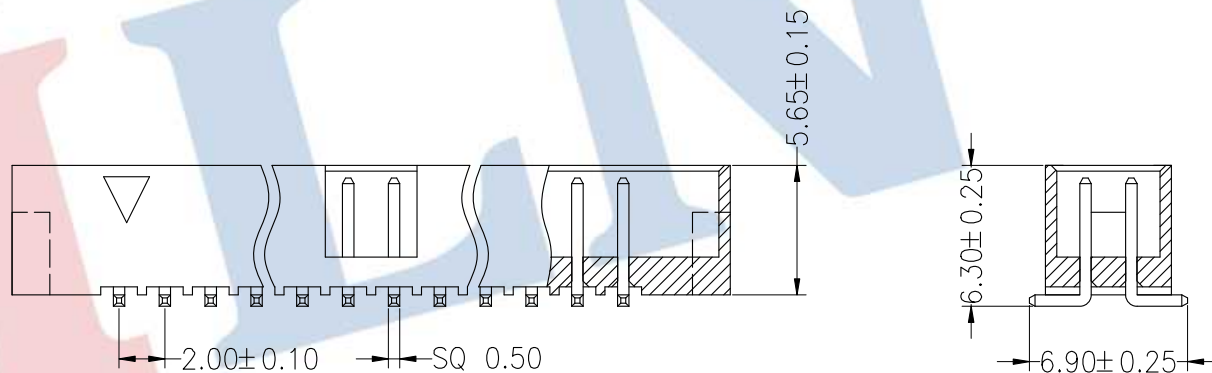
Recommended P.C.B Layout(Top Side)
 (PCB BOARD TOLERANCE±0.05)



Ordering Information

3220 XX M XX X B K00 X 0X

- No.of Pins 10~100P
- Contact Plating
 G0:Gold Flash
 G1:1u" Gold
 G2:1.5u" Gold
 G3:2u" Gold
 G4:3u" Gold
 G5:5u" Gold
 G6:10u" Gold
 G7:15u" Gold
 G8:30u" Gold
 S0:Gold Flash/Tin
 SN:Tin
- Insulator Material Option
 C=BK-PA6T
 E=BK-PA9T
 F=BK-LCP
- Packing
 A=Tray
 T=Tube
 P=Tube+Cap
 R=Reel+Cap



				OPERATION		DRAW	YiYuSheng	18.03.28	SCALE	FIT	JILN ® 深圳市锦凌电子有限公司 SHENZHEN JINLING ELECTRONICS CO.,LTD Tel: 86-755-27483253 Fax: 86-755-2997-5588	
				X.X	±0.30				UNIT	mm		
				X.XX	±0.20				SIZE	A4		
				X.XXX	±0.10				SHEET	1/1		
A0	2018.03.28	NEW DRAWING		Angle	±3°	APPROVE		PROJ.	⌀	PART NO.	3220XXMXXXBK00X0X	
REV	DATE	MODIFICATION DESCRIPTION		DIM	TOL					TITLE:	2.0DC3 Npin H5.65 SMT 两边带缺口	